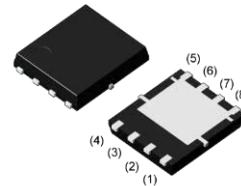


V_{DSS}	100V
R_{DS(on)}(typ.)	4.6mΩ
I_D	70A
P_D	142W

Outline

P PAK 5X6



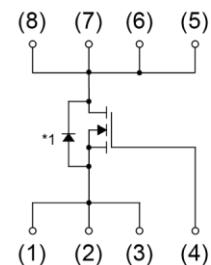
Features

- 100V, 70A, R_{DS(ON)} = 4.6mΩ@V_{GS} = 10V
- Improved dv/dt capability
- Fast switching
- Green Device Available

Applications

- MB / VGA / Vcore
- POL Applications
- SMPS 2nd SR

- (1) Source
 (2) Source
 (3) Source
 (4) Gate
 (5) Drain
 (6) Drain
 (7) Drain
 (8) Drain
- *1 Body Diode



Type	Reel size (mm)	330
	Tape width (mm)	12
	Basic ordering unit (pcs)	5000
	Taping code	D3
	Marking	AD100N70D5

Absolute Maximum Ratings T_c=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	100	V
V _{GS}	Gate-Source Voltage	20/-12	V
I _D	Drain Current – Continuous (T _c =25)	70	A
	Drain Current – Continuous (T _c =100)	44	A
I _{DM}	Drain Current – Pul sed ¹	280	A
E _{AES}	Single Pulse Avalanche Energy ²	320	mJ
I _{AS}	Single Pulse Avalanche Current ²	80	A
P _D	Power Dissipation (T _c =25)	142	W
	Power Dissipation – Derate above 25.	1.14	W/°C
T _{STG}	Storage Temperature Range	-50 to 150	
T _J	Operating Junction Temperature Range	-50 to 150	

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	/W
R _{θJC}	Thermal Resistance Junction to Case	---	0.88	/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	100	---	---	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=100\text{V}$, $V_{GS}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=80\text{V}$, $V_{GS}=0\text{V}$, $T_J=85^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=20\text{V}$, $V_{DS}=0\text{V}$	---	---	100	nA

On Characteristics

$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}$, $I_D=20\text{A}$	---	4.6	5.5	$\text{m}\Omega$
		$V_{GS}=10\text{V}$, $I_D=20\text{A}$ ($T_J=125^\circ\text{C}$)	---	8.1	---	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}$, $I_D=10\text{A}$	---	6.2	7.8	$\text{m}\Omega$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu\text{A}$	1	1.6	2.5	V
g_{fs}	Forward Transconductance	$V_{DS}=10\text{V}$, $I_D=5\text{A}$	---	18	---	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge ^{3,4}	$V_{DS}=80\text{V}$, $V_{GS}=10\text{V}$, $I_D=10\text{A}$	---	58.2	100	nC
Q_{gs}	Gate-Source Charge ^{3,4}		---	9.2	18	
Q_{gd}	Gate-Drain Charge ^{3,4}		---	20.8	30	
$T_{d(on)}$	Turn-On Delay Time ^{3,4}	$V_{DD}=50\text{V}$, $V_{GS}=10\text{V}$, $R_G=6\Omega$ $I_D=1\text{A}$	---	24	48	ns
T_r	Rise Time ^{3,4}		---	19.8	39	
$T_{d(off)}$	Turn-Off Delay Time ^{3,4}		---	46	92	
T_f	Fall Time ^{3,4}		---	26	52	
C_{iss}	Input Capacitance	$V_{DS}=25\text{V}$, $V_{GS}=0\text{V}$, $F=1\text{MHz}$	---	4570	9100	pF
C_{oss}	Output Capacitance		---	1180	2300	
C_{rss}	Reverse Transfer Capacitance		---	49	98	
R_g	Gate resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, $F=1\text{MHz}$	---	2	4	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_b=0\text{V}$, Force Current	---	---	70	A
	Pulsed Source Current		---	---	140	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1	V
t_{rr}	Reverse Recovery Time	$V_{GS}=0\text{V}$, $I_s=10\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$	---	61.6	---	ns
Q_{rr}	Reverse Recovery Charge	$T_J=25^\circ\text{C}$	---	120	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{DD}=25\text{V}$, $V_{GS}=10\text{V}$, $L=0.1\text{mH}$, $I_{AS}=80\text{A}$, $R_G=25\Omega$ Starting $T_J=25^\circ\text{C}$.
3. The data tested by pulsed, pulse width = 300us, duty cycle = 2%.
4. Essentially independent of operating temperature.

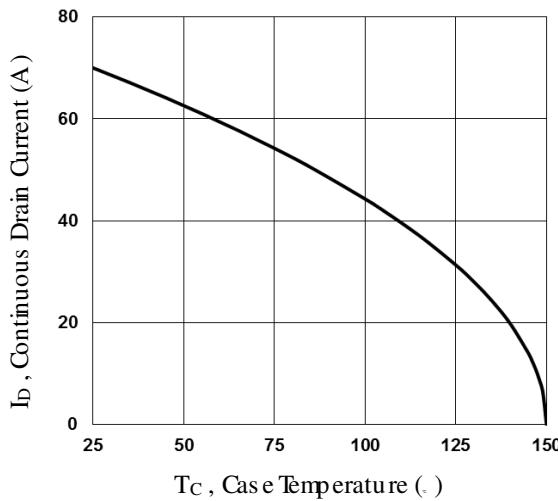


Fig.1 Continuous Drain Current vs. Tc

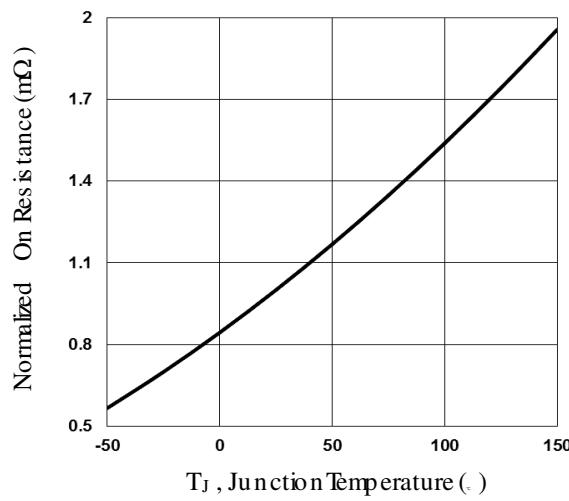


Fig.2 Normalized RDSON vs. Tj

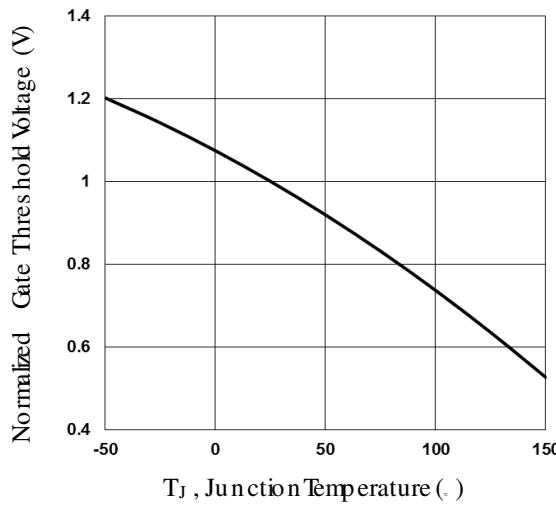


Fig.3 Normalized Vth vs. Tj

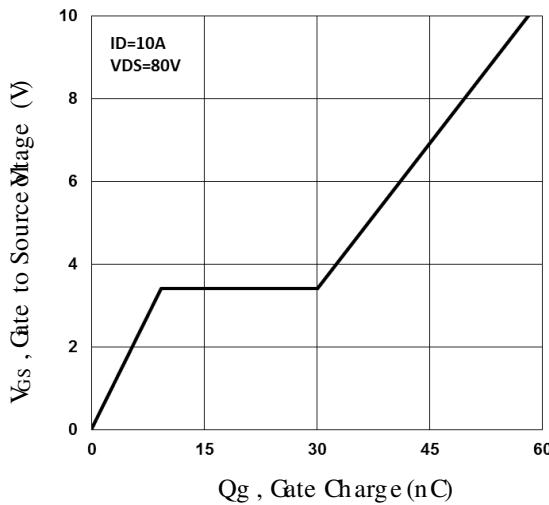


Fig.4 Gate Charge Characteristics

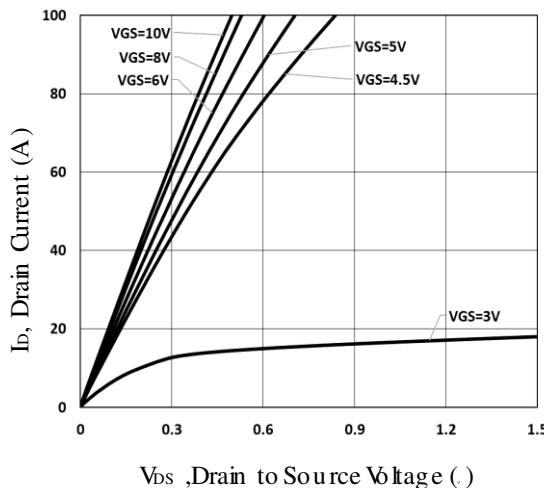


Fig.5 Typical Output Characteristics

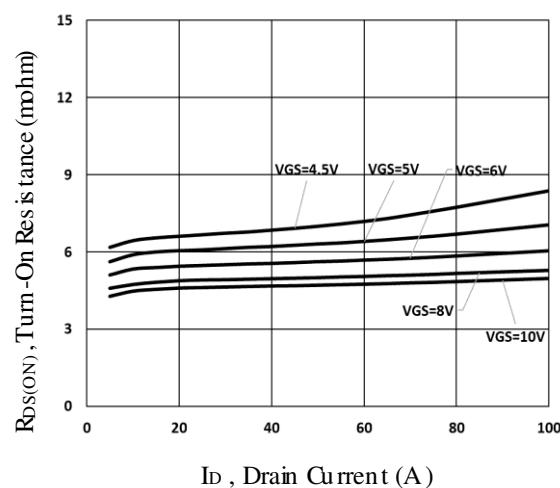


Fig.6 Turn-On Resistance vs. ID

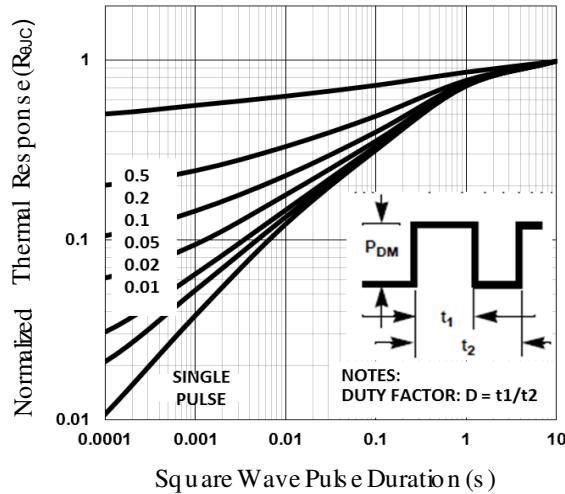


Fig.7 Normalized Transient Impedance

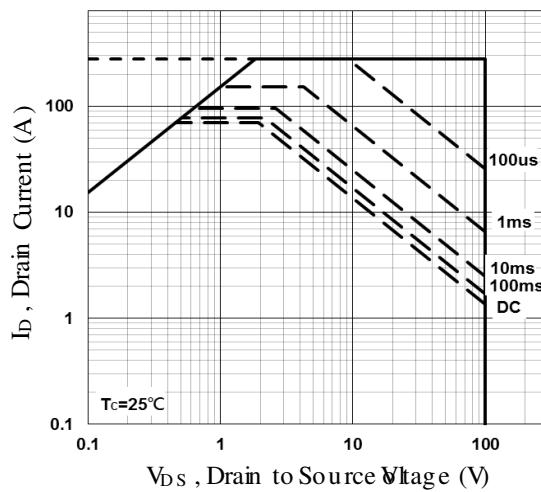


Fig.8 Maximum Safe Operation Area

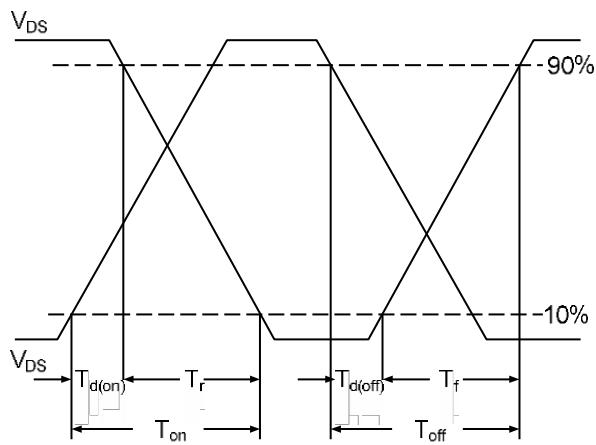


Fig.9 Switching Time Waveform

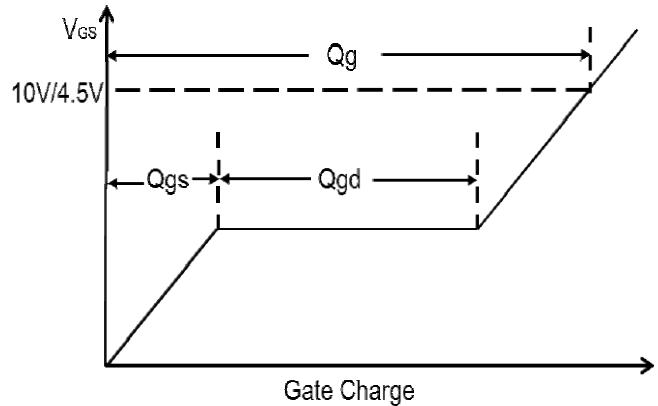
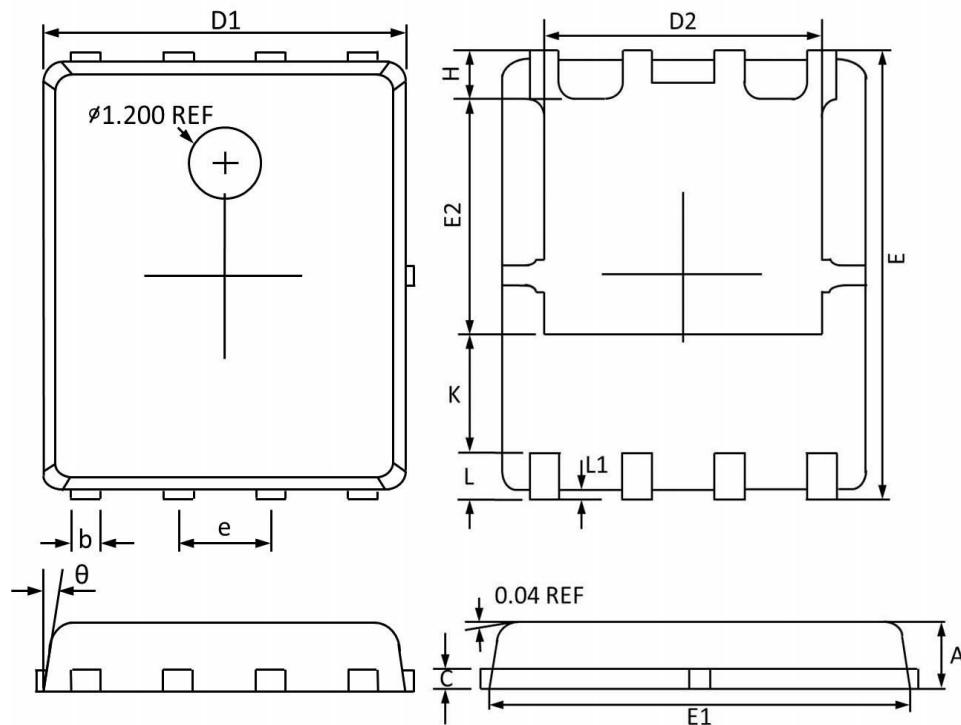


Fig.10 Gate Charge Waveform

PPAK5x6 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.100	0.800	0.043	0.031
b	0.510	0.330	0.020	0.013
C	0.300	0.200	0.012	0.008
D1	5.100	4.800	0.201	0.189
D2	4.100	3.610	0.161	0.142
E	6.200	5.900	0.244	0.232
E1	5.900	5.700	0.232	0.224
E2	3.780	3.350	0.149	0.132
e	1.27BSC		0.05BSC	
H	0.700	0.410	0.028	0.016
K	1.500	1.100	0.059	0.043
L	0.710	0.510	0.028	0.020
L1	0.200	0.060	0.008	0.002
θ	12°	0°	12°	0°